In re application of: Yamazaki et al.
Serial No: 09/815,661
Filed: March 23, 2001
For: Method Of Manufacturing A Light Emitting Device
Art Unit: 2812
Examiner: S. Mulpuri

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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| 1 | Shunpei YAMAZAKI and Takeshi FUKUNAGA | Edward D. Manzo, Esq.  
200 West Adams Street, Suite 2850  
Chicago, Illinois 60606 |
| 2a | Name and Address of Receiving Party(ies):  
Name: Semiconductor Energy Laboratory Co., Ltd.  
Address: 398, Hase, Atsugi-shi, Kanagawa-ken  
243-0036 Japan | |
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X Assignment  
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| 4 | Application Number(s) or Patent number(s) (If this document is being filed together with a new application, the execution date of the application is: 3/13/01; 3/09/01)  
4a. Patent Application No.(s) 09/815,661  
4b. Patent No.(s) ________ | Total Fee (37 CFR 3.41): $40.00 (Check already sent)  
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| 6 | Statement and Signature:  
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  
Mark J. Murphy  
Name of Person Signing  
Reg. No. 34,225  
Date: May 19, 2004 | |

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In re application of: Yamazaki et al.
Serial No: 101654
Filed: Herewith
For: Method Of Manufacturing A Light Emitting Device
Art Unit: 379
Examiner: 277

3-23-01
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Washington, D.C. 20231

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Name: Semiconductor Energy Laboratory Co., Ltd.
Address: 398, Hase, Atsugi-shi, Kanagawa-ken
243-0036 Japan

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6. Total Number of Applications and Patents Involved: 1

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Name of Person Signing
Reg. No. 34,225
Date: March 19, 2001

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PATENT
REEL: 015368 FRAME: 0190
ASSIGNMENT

Identity Of The Patent Application. I am the inventor (or one joint inventor) of a patent application that I am assigning. The patent application I am assigning is entitled METHOD OF MANUFACTURING A LIGHT EMITTING DEVICE which I executed herewith. If the patent application has already been filed, it received serial number __________ and bears a filing date of __________.

The Assignee and The Assignment. I assign my patent rights to __Semiconductor Energy Laboratory Co., Ltd., a corporation organized according to the laws of Japan, having a place of business at __398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan__ (hereinafter "the Assignee"). The rights I assign are my entire right, title and interest in the invention or improvements disclosed in the patent application and any and all other applications for United States Letters Patent which I may file, either solely or jointly with others, on the invention or improvements, including all continuations, divisionals, and continuations-in-part, and in any and all United States Letters Patent which may be obtained on any of said applications, and in any reissue or extension thereof. I also assign to the Assignee all priority rights under the International Convention. I agree to execute, at the request of the Assignee, all documents in connection with any application for United States letters patent therefor.

Payment Received. I am making this assignment in consideration of One Dollar and other good and valuable consideration. I acknowledge the receipt and sufficiency of the consideration.

Authorizations. I request the U.S. Commissioner of Patents and Trademarks to issue the Letters Patent to the Assignee. I authorize the attorney(s) of record in the application to insert in this assignment document the date and serial number of the application.

Further Acts. I agree, upon the request and at the expense of the Assignee, to execute any divisional, continuation or substitute application for the invention or improvements, and any oath, declaration or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon the application. I agree to perform, upon request, any affirmative acts to obtain said Letters Patent of the United States and to vest in the Assignee all rights therein, so that the Letters Patent will be held and enjoyed by the Assignee, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me if this assignment had not been made.

Interference. In the event that any application or Letters Patent that I now assign becomes involved in interference, I agree to cooperate to the best of my ability in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof.

Name: Shunpei YAMAZAKI
Date: 03/13/2001

Name: Takeshi FUKUNAGA
Date: 03/09/2001

RECORDED: 05/19/2004